

Structural and optical properties of chemical bath deposited Ni doped Cd–Se thin films

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Abstract: Cd–Se thin films of varying thicknesses were prepared on glass substrate by chemical bath deposition technique at room temperature in which selenium dioxide is source of Se^{2-} while cadmium acetate is source of Cd^{2+} ions. Ammonia was used as complexing agent. Nickel doping is achieved by adding $\text{Ni}(\text{NO}_3)_2$ solution to the bath. Approximate thickness was measured by gravimetric method. Band gap of the films was determined by measuring percent transmittance of film at various wavelengths. The band gap and thickness of the film were found to increase with increase of Ni concentration in films. The composition and structural characterization was carried out by using EDAX and SEM.

Keywords: Ni doped Cd–Se thin films; Chemical bath deposition; Band gap

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1. Introduction

Cadmium selenide (CdSe) is a II–VI group semiconductor compounds having suitable band gap (1.7 eV), high absorption coefficient and can be utilized in a number of opto-electronic devices such as PEC cells [1–3], hybrid solar cells [4], transistors [5], light emitting diodes [6], etc. A variety of deposition techniques such as electrode deposition [7, 8], vacuum evaporation [9–11] and chemical bath deposition (CBD) [12–14] have been used to deposit CdSe thin films. Among them, CBD method is the best suited for thin film deposition because of its convenience, least expenses and its ability to deposit solid solutions without the aid of sophisticated instrumentation [15]. We have used this method successfully for getting uniform, well adherent, nearly stoichiometric CdSe films, with fewer defects [12]. In recent year's major attention have been given to the investigation of electrical and optical properties of CdSe thin films in order to improve the performances of the devices and for finding new applications [16–20]. Various researchers demonstrated the higher energy band gap ternary system (doped with other metal)

for increasing the short circuit current in the solar cell [21]. Investigation have also been made on the improved properties of CdSe thin film doped with Al [22], In [23], Hg [24], Cu [25], Sn [26], Fe [27]. Literature survey shows that there is no work on Ni doped CdSe films. The objective of present work is to study the effect of Ni doping on optical and structural properties of CdSe thin films prepared by CBD technique at room temperature on glass substrate. Recently there are many reports on various thin films prepared by different techniques [28–34].

2. Experimental details

2.1. Thin film deposition

The thin films of CdSe were deposited onto glass substrates with dimensions (76 mm × 26 mm × 1 mm) of a standard microscope glass. Glass substrates were immersed in chromic acid solution for 1 h then washed with distilled water and acetone and dried in oven.

The adhesion with the substrate is of prime importance for the quality of the deposited thin films. To improve the film adhesion, the glass substrates were immersed in a diluted solution of tin chloride (SnCl_2) prior to the deposition process and afterwards thermally treated at 200 °C. Chemical deposition of CdSe film is carried out at room

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temperature. As precursor of selenide ions, sodium selenosulphate (Na_2SeSO_3) was used. 0.05 M Na_2SeSO_3 solution was prepared by refluxing the mixture of 0.05 M sodiumsulphate (Na_2SO_3) and 0.05 M selenium dioxide (SeO_2) solutions in equal proportion with constant stirring for 5 h at 110 °C. The deposition bath is prepared by taking 30 ml freshly prepared 0.02 M cadmium acetate ($(\text{CH}_3\text{COO})_2\text{Cd}\cdot 2\text{H}_2\text{O}$) and 50 ml 0.05 M Na_2SeSO_3 in 250 ml beaker. pH of the bath solution is adjusted to 9.0 by adding excess of liquor ammonia. The glass substrates were immersed in solution. The solution was continuously stirred using mechanical stirrer. The substrates with CdSe coating were taken out of the bath after deposition period of 16 and 18 h, washed with water and dried using hot air blower. For Ni doping, to above solution $\text{Ni}(\text{NO}_3)_2$ solution was added in varying quantities (0.5, 1.0, 1.5 and 2.0 ml). $\text{Ni}(\text{NO}_3)_2$ solution was prepared by dissolving 1 mg of pure nickel metal in 25 ml of concentrated HNO_3 under vigorous stirring.

2.2. Characterization of thin film

Approximate thickness of the film was measured by gravimetric method (weight difference method). In gravimetric method, the thickness of film was determined by weighing the glass substrate before and after deposition on the microbalance of sensitivity 0.0001 g, assuming the density of film to be same as that of bulk material, thickness may be calculated by using the relation.

$$d = \frac{M}{A} \times \frac{1}{\rho}, \quad (1)$$

where A is the surface area of the films, M is mass of the films, ρ is the density of the CdSe.

The microstructure of the films was studied by using a scanning electron microscope (JEOL Model-6360), attached with an energy dispersive X-ray analysis (EDAX) to measure quantitatively the sample composition. The film was coated with 10 nm gold layer using Polaron SEM sputter coating unit, before taking micrographs and EDAX. The elemental composition of the CdSe and Ni doped CdSe deposited films were carried out by using the EDAX technique. The optical absorbance/transmittance of the films were studied at room temperature in the spectral range of 500–1,000 nm using UV Visible spectrophotometer (Chemito, spectroscan UV 2700) from which the band gap is calculated by using the formula

$$E = \frac{hc}{\lambda}, \quad (2)$$

where h is plank constant, c is velocity of light, and λ is wavelength.

3. Result and discussion

3.1. Reaction mechanism

The deposition of CdSe thin film takes place when the ionic product (IP) of Cd^{2+} and Se^{2-} ions exceeds the solubility product (SP) of CdSe (i.e. $\text{IP} \geq \text{SP}$ (10^{-33})). The CdSe deposition takes place according to the following steps [28]:

The hydrolysis of sodium selenosulphate (Na_2SeSO_3) in solution to give Se^{2-} ions is according to the chemical reaction

Table 1 Thickness of CdSe and CdNiSe thin film at different concentration of Ni as well as deposition time

Deposition time (h)	Thickness (μm)	Composition	Doping (ml)
16	1.55	CdSe	0
18	1.62	CdSe	0
16	1.63	$\text{Cd}_{43.99}\text{Ni}_{0.49}\text{Se}_{55.52}$	0.5
18	1.68	$\text{Cd}_{43.99}\text{Ni}_{0.49}\text{Se}_{55.52}$	0.5
16	1.64	$\text{Cd}_{45.65}\text{Ni}_{0.83}\text{Se}_{53.51}$	1
18	1.7	$\text{Cd}_{45.65}\text{Ni}_{0.83}\text{Se}_{53.51}$	1
16	1.72	$\text{Cd}_{60.30}\text{Ni}_{1.32}\text{Se}_{38.37}$	1.5
18	1.76	$\text{Cd}_{60.30}\text{Ni}_{1.32}\text{Se}_{38.37}$	1.5

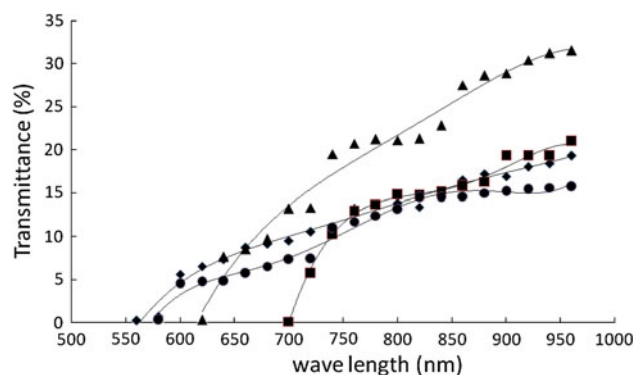
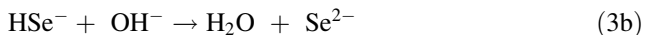


Fig. 1 Variation of %transmittance with wavelength for films; CdSe (■), $\text{Cd}_{43.99}\text{Ni}_{0.49}\text{Se}_{55.52}$ (▲), $\text{Cd}_{45.65}\text{Ni}_{0.83}\text{Se}_{53.51}$ (●), $\text{Cd}_{60.30}\text{Ni}_{1.32}\text{Se}_{38.37}$ (◆)

Table 2 Band gap of CdSe and Ni doped CdSe thin films

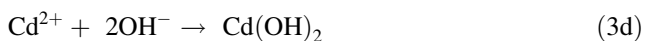
Thin films	Band gap (eV)	λ max (nm)
CdSe	1.77	700
$\text{Cd}_{43.99}\text{Ni}_{0.49}\text{Se}_{55.52}$	1.88	640
$\text{Cd}_{45.65}\text{Ni}_{0.83}\text{Se}_{53.51}$	2.07	600
$\text{Cd}_{60.30}\text{Ni}_{1.32}\text{Se}_{38.37}$	2.21	560



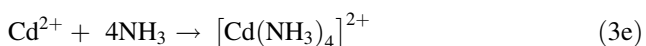
Similarly, the hydrolysis of ammonia in water to give OH^- ions,



When the ammonia is added to the Cd^{2+} salt solution, $\text{Cd}(\text{OH})_2$ starts precipitating when the SP of $\text{Cd}(\text{OH})_2$ is exceeded,



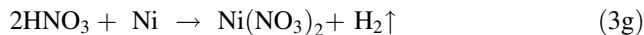
The $\text{Cd}(\text{OH})_2$ precipitate dissolves in excess ammonia solution to form the complex cadmium tetra-ammine ions $[\text{Cd}(\text{NH}_3)_4]^{2+}$ as follows,



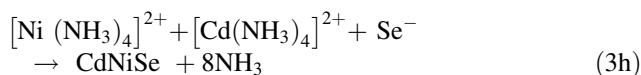
Finally, the CdSe thin film formation takes place,



Ordinarily nickel metal was dissolved in concentrated nitric acid (HNO_3) the doping of nickel was carried by adding the different volumes of nickel nitrate ($\text{Ni}(\text{NO}_3)_2$) solution to the above chemical bath. The reaction mechanism is as follows:



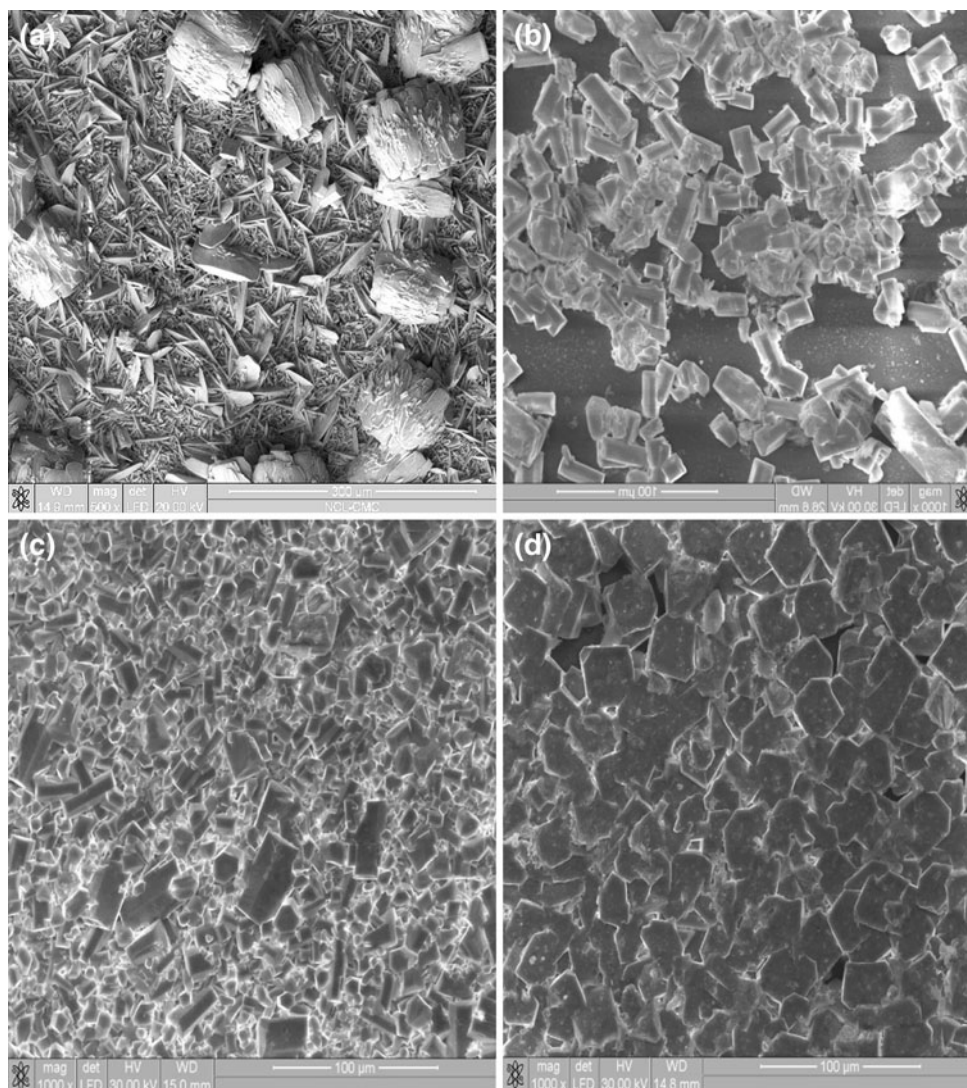
Finally we get CdNiSe



3.2. Growth mechanism

The growth mechanism of thin films in the CBD method can take place either in the bulk of the solution (homogeneous precipitation process) or at the substrate surface

Fig. 2 SEM images of **a** CdSe, **b** $\text{Cd}_{43.99}\text{Ni}_{0.49}\text{Se}_{55.52}$, **c** $\text{Cd}_{45.65}\text{Ni}_{0.83}\text{Se}_{53.51}$, **d** $\text{Cd}_{60.30}\text{Ni}_{1.32}\text{Se}_{38.37}$ thin film



(heterogeneous process) [35]. Froment and Lincot have proposed that the first process is associated with the agglomeration of colloids formed in the solution by the homogeneous reaction. It can be considered as a “cluster-by

cluster” growth, leading to particulate film. The second process is the growth mechanism involving the reaction of atomic species at the surface; it corresponds to an atom-by-atom process commonly known as an “ion-by-ion”

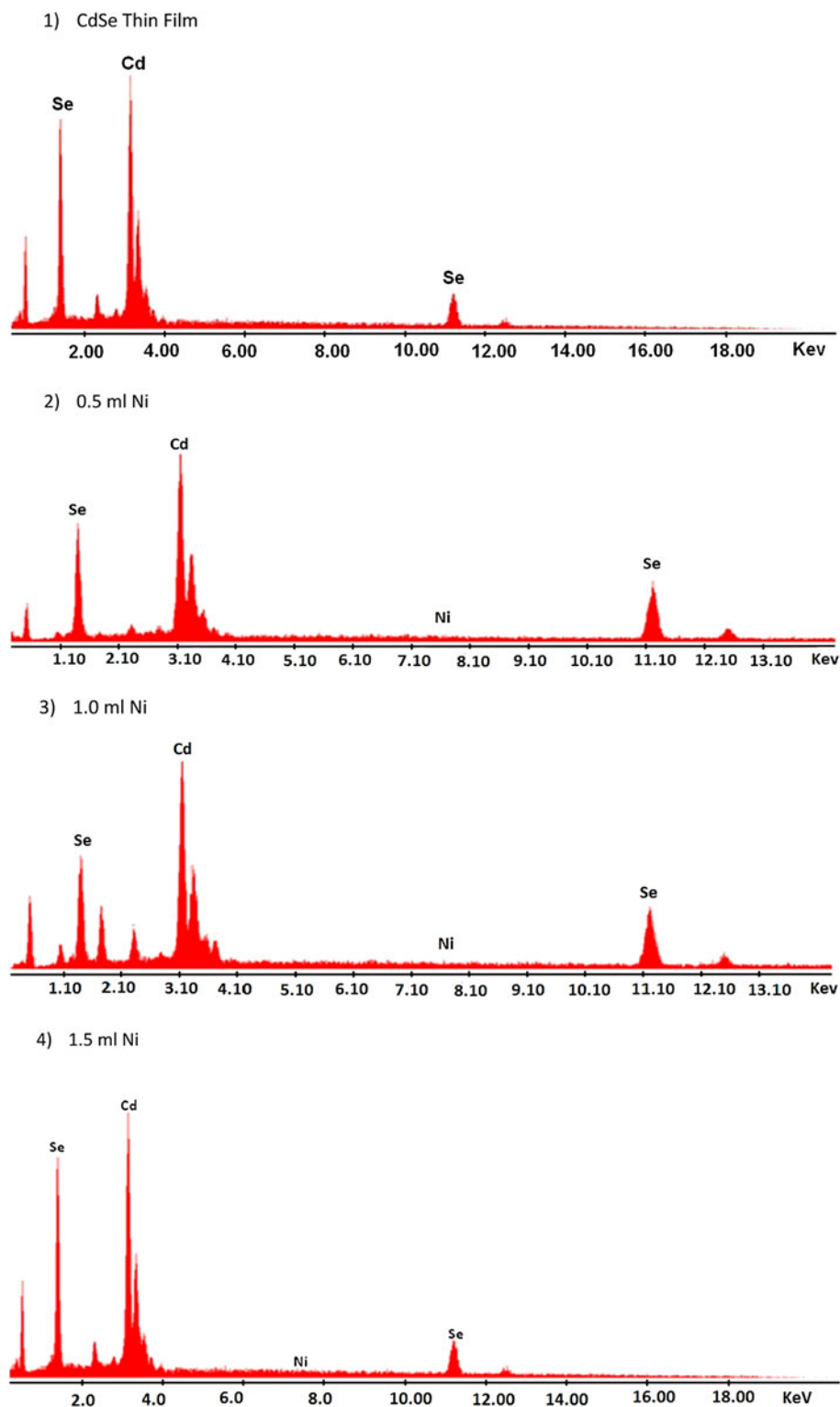


Fig. 3 EDAX analysis of CdSe and Ni doped CdSe thin film

Table 3 Elemental analysis of CdSe and Ni doped CdSe thin films

Composition	Amount of Ni(NO ₃) solution added (ml)	Element	Weight %	Atomic %
CdSe	0	Cd	59.8	50.5
		Se	41.2	49.5
CdNiSe	0.5	Cd	54.56	45.65
		Ni	0.5154	0.49
		Se	44.91	53.51
CdNiSe	1.0	Cd	52.90	43.99
		Ni	0.61	0.83
		Se	46.46	55.52
CdNiSe	1.5	Cd	68.55	60.30
		Ni	0.79	1.32
		Se	30.65	38.37

nucleation and growth mechanism. The predominance of one given mechanism is governed by classical laws of homogeneous versus heterogeneous nucleation on a solid surface, involving the super saturation ratio in the solution and the catalytic activity of the substrate and the rate of stirring [36]. In short, the growth mechanism depends on the experimental conditions.

In the present study, due to the absence of thermal and mechanical agitation, a strong $[\text{Cd}(\text{NH}_3)_4]^{2+}$ complex, and a stable Na_2SeSO_3 precursor, the Cd^{2+} and Se^{2-} ions were slowly released in the solution, which then condense with an “ion by ion” basis on the substrates that are suitably mounted in the solution. CBD of semiconductor thin films involves a nucleation/incubation phase followed by a growth phase and terminal phase [36]. In the present study the film thickness was linearly increased with time (Table 1). CdSe films were extremely adherent to the substrate and did not peel off although the deposition was carried out for prolonged time intervals. After a certain time interval or terminal thickness some powdery CdSe material was deposited over the adherent film surface that could be removed with water. The Ni doped CdSe thin film were prepared by using same technique. After addition of NiNO_3 in a bath of CdSe a heterogeneous reaction and precipitation occurs to form CdNiSe thin film [37]. The film thickness lies between 1.55 and 1.78 μm and it increases with increases in the concentration of Ni as well as deposition time (Table 1).

3.3. Optical properties

Figure 1 shows transmittance spectra of the CdSe and Ni doped CdSe films. Band gap value is calculated by using Eq. (2) for wavelength at which Percentage transmittance is minimum or zero. The value of this wavelength decreases as the concentration of Ni in the film increases. The band

gap value of the undoped CdSe film (1.77 eV) was found somewhat smaller than the Ni doped CdSe thin film (1.88–2.38 eV). Also as the Ni concentration in the film increases band gap increases (Table 2). This may be due to change in structure and stoichiometry of film as Ni content in the film changes as can be seen from SEM images. As the structure changes the lattice constants are also changing which are related to band gap [38–40].

3.4. Structural and Elemental properties

Scanning electron microscopy (SEM) is a convenient technique to study microstructure of thin films. Figure 2a–d shows the SEM pictures of the CdSe and Ni doped CdSe thin films of various atomic percent of Ni 0.49, 0.83, 1.32, respectively at room temperature. Figure 2a shows irregular shape crystallites and some of them are agglomerated and chunk type crystals, in Fig. 2b, c most of the crystals are rectangular with smooth surface, in Fig. 2d cubic crystals with large surface area with uniform coating are seen.

From images, it is clear that the all films were compact and homogeneous with well defined, fine grain background. As the concentration of Ni increases, there is a sharp change in structure as well as thickness of the film. Increase in the thickness of the films shows a substantial granular growth and dense porous network structure. Increase in overgrowth of surface particles with thickness is well known for chemically deposited films [41]. Figure 3 shows a typical EDAX pattern and the details of the relative analysis are depicted in Table 3. The strong peaks for Cd and Se were found in the spectrum, and no impurity peaks were detected in the EDAX spectrum. The average atomic percentage ratio of Cd:Se was found to be 50.5:49.5, showing that the film was in good stoichiometric ratio. The EDAX analysis results indicated that the Cd:Se ratios are very close to a 1:1 stoichiometric composition as shown in (Table 3) and the Cd:Ni:Se films having the average atomic percentage ratio were found to be 43.99:0.49:55.52, 43.65:0.83:53.51, 60.30:1.32:38.37 for 0.5, 1, 1.5 ml Ni concentration, respectively.

4. Conclusions

CdSe and Ni doped CdSe thin films were successfully deposited by using CBD technique from aqueous medium at room temperature. Thickness of the films was measured by gravimetric method and it was found to be increased with the deposition time as well as the increased Ni concentration. The structure of the films consists of fine and highly oriented grains. The crystallites size, i.e. the thickness increases when the Ni content and the deposition time

increases. A direct optical band gap of was found from transmittance spectra. As the concentration of Ni in the film increases the band gap of the film increases.

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References

- [1] K Rajeshwar *Adv. Mater.* **4** 23 (1992)
- [2] W Lee, W-C Kwak, S Ki Min, J-C Lee, W-S Chae, Y-M Sung and S-H Han *Electrochem. Commun.* **10** 1699 (2008)
- [3] A Kongkanand, K Tvrdy, K Takechi, M Kuno and P V Kamat, *J. Am. Chem. Soc.* **130** 4007 (2008)
- [4] L Han, D Quin, X Jiang, Y Liu, L Wang, J Chen and Y Cao *Nanotechnology* **17** 4737 (2006)
- [5] C J Panchal *Indian J. Phys.* **79** 1269 (2005)
- [6] S Nizamoglu, T Ozel, E Sari and H V Demir *Nanotechnology* **18** 065709 (2007)
- [7] S M Pawar, A V Moholkar and C H Bhosale *Mater. Lett.* **61** 1034 (2007)
- [8] C M Shen, X G Zhang and H L Li *Appl. Surf. Sci.* **240** 34 (2005).
- [9] K N Shreekanth, B V Rajendra, V B Kasturi and G K Shivakumar *Cryst. Res. Technol.* **38** 20 (2003)
- [10] S Velumani, X Mathew, P J Sebastian, S K Narayandass and D Mangalaraj *Sol. Energy Mater. Sol. Cells* **76** 347 (2003)
- [11] Z Aneva, D Nesheva, C Main, S Reynolds, A G Fitzgerald and E Vateva *Semicond. Sci. Technol.* **23** 095002 (2008)
- [12] H E Esparza-Ponce, J Hernandez-Borja, A Reyes-Rojas, M Cervantes-Sancheza, Y V Vorobiev, R Ramirez-Bon, J F Perez-Robles and J Gonzalez-Hernandez *Mater. Chem. Phys.* **113** 824 (2009)
- [13] R B Kale and C D Lokhande *Semicond. Sci. Technol.* **20** 1 (2005)
- [14] S Bhushan and A Shrivastava *Indian. J. Phys.* **84** 1517 (2010)
- [15] S Erat, H Metina and M Ari *Mater. Chem. Phys.* **111** 114 (2008)
- [16] O Oduor and R D Gould *Thin Solid Films* **270** 387 (1995)
- [17] K P Mohanchandra and J Uchil *Thin Solid Films* **305** 124 (1997)
- [18] M J Lee and S-C Lee *Solid State Electron.* **43** 833 (1999)
- [19] D Samanta, B Samanta, A K Chaudhuri, S Ghorai and U Pal *Semicond. Sci. Technol.* **11** 548 (1996)
- [20] U Pal, D Samata, S Ghorai and A K Chaudhuri *J. Appl. Phys.* **74** 6368 (1993)
- [21] R Chandran and G Suresh *Chalcogenide Lett.* **8** 689 (2011)
- [22] T O Poehler and D Abraham *Appl. Phys. Letters.* **6** 125 (1965)
- [23] T Mahalingam, R Mariappan, V Dhanasekaran, S M Mahan, G Ravi and J P Chu *Chalcogenide Lett.* **7** 669 (2010)
- [24] V M Bhuse *Mater. Chem. Phys.* **91** 60 (2005)
- [25] K Subba Ramiah, Y K Su, S J Chang, F S Juang, K Ohdaira, Y Shiaki, H P Liu, I G Chen and A K Bhatnagar *J. Cryst. Growth* **224** 74 (2001)
- [26] E U Masumdar, V B Gaikwad, V B Pujari, P D More, and L P Deshmukh *Mater. Chem. Phys.* **77** 669 (2003)
- [27] S Thanikaikarasan, K Sundaram, T S Velumani and J-K Rhee *Mater. Sci. Eng B* **174** 242 (2010)
- [28] P Saikia, A Borthakur and P K Saikia *Indian J. Phys.* **85** 551 (2011)
- [29] A T M K Jamil and H Noguchi *Indian J. Phys.* **85** 737 (2011)
- [30] T P Rao, M C Santhosh Kumar and V Ganesan *Indian J. Phys.* **85** 1381 (2011)
- [31] L Daoyong, O Yu, C Li, C Weiran and S Shaohua *Indian J. Phys.* **85** 293 (2011)
- [32] D Kalhar, R Zahir, S A Ketabi and A Ebrahimzad *Indian J. Phys.* **84** 539 (2010)
- [33] B Saha, R Thapa, N S Das and K K Chattopadhyay *Indian J. Phys.* **84** 681 (2010)
- [34] B Saha, R Thapa, S Jana and K K Chattopadhyay *Indian J. Phys.* **84** 1341 (2010)
- [35] R B Kale and C D Lokhande *J. Phys. Chem. B* **109** 20288 (2005)
- [36] M Froment and D Lincot *Electrochim. Acta* **40** 1293 (1995)
- [37] D A Johnston, M H Carletto, K T R Reddy, I Forbes and R W Miles *Thin Solid Films* **102** 403 (2002)
- [38] I Vurgaftman and J R Meyer *J. Appl. Phys.* **94** 3675 (2003)
- [39] R Andreichin, A Ivanova and U Stanislavova *Proceedings 5th IMEKO-symposium on photon detractors (pt. II)* (ed.) J. Schanda (Bulgaria: Varna) (1971)
- [40] M C Santhosh Kumar and B Pradeep *Indian. J. Phys.* **85** 401 (2011)
- [41] G Hodes, A Albu-Yaran, F Decker and P Matsuke *Phys. Rev. B* **36** 4215 (1987)